General Description

The SDC266 is an integrated circuit which includes Hall sensor and output drive circuits. It's widely used in 2-phase brushless DC motor and fan. It's composed of power reverse protection circuit, high stable voltage regulator, Hall voltage generator, a differential amplifier, Schmitt trigger and open collector output (DO, DOB).

In the case of power supply reverse connecting, the internal protection diode can protect IC but not protect coil, a protection diode can be added if necessary.

Features

- Wide operating voltage range: 3.5V~24V
- 250mA(AVG) output sink current
- Building-in protection diode
- Operating temperature range: -20°C~85°C
- Package: TO-94

Applications

- Brushless DC motor
- Brushless DC fan
- Revolution counting
- Speed measurement

TO-94

Figure 1. Package Type

Pin Configuration

Package: TO-94

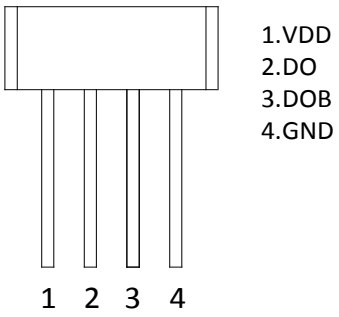


Figure 2. Pin Configuration

Pin Number	Pin Name	Function
1	VCC	Supply voltage pin
2	DO	Output 2 pin
3	DOB	Output 3 pin
4	GND	Ground pin

Table 1. Pin Description

Functional Block Diagram

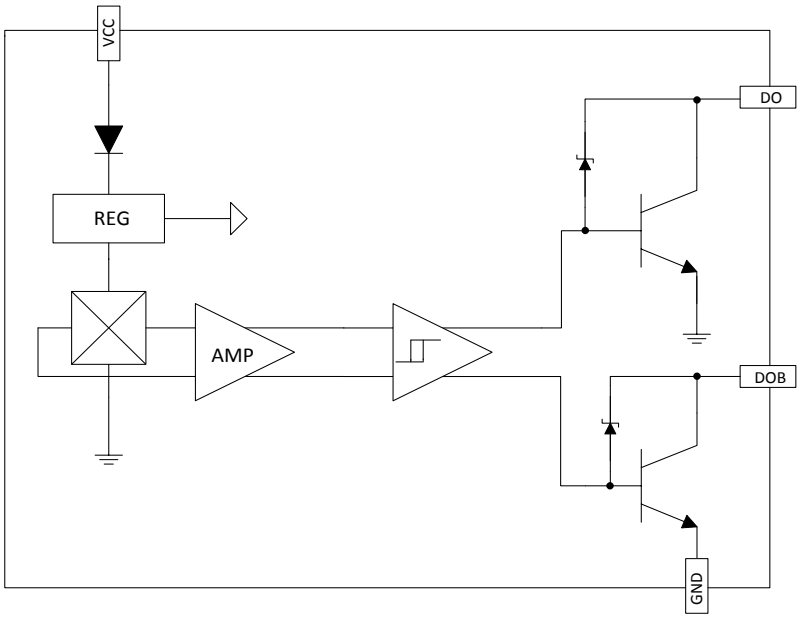
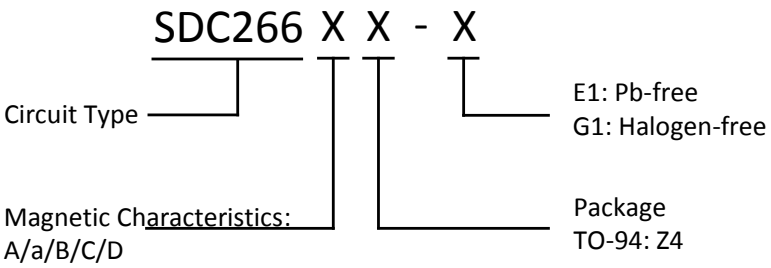


Figure 3. Functional Block Diagram

Ordering Information



Package	Temperature Range	Part Number		Marking ID		Packing Type
		Pb-free	Halogen-free	Pb-free	Halogen-free	
TO-94	-20°C~85°C	SDC266AZ4-E1	SDC266AZ4-G1	266	266G	Bulk
		SDC266BZ4-E1	SDC266BZ4-G1	266	266G	Bulk
		SDC266CZ4-E1	SDC266CZ4-G1	266	266G	Bulk
		SDC266DZ4-E1	SDC266DZ4-G1	266	266G	Bulk

Absolute Maximum Ratings (Note: Stresses greater than those listed under absolute maximum ratings may cause permanent damage to the device.)

Parameter		Symbol	Value	Units
Supply Voltage		V_{CC}	26.5	V
Output Voltage		V_{OUT}	26.5	V
Reverse voltage		V_{RCC}	-20	V
Magnetic flux density		B	unlimited	GS
Output current	Continuous	I_{OUT}	250	mA
	Hold		400	
	Peak		700	
Storage temperature range		T_S	-65~150	°C
Package power dissipation		P_D	550	mW
ESD, HBM model per Mil-Std-883, Method 3015		HBM	4000	V
ESD, MM model per JEDEC EIA/JESD22-A115		MM	400	V
Latch-up test per JEDEC 78		-	200	mA
Maximum junction temperature		T_J	150	°C

Table 2. Absolute Maximum Ratings

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
Power supply	V_{CC}	3.5	24	V
Operation temperature	Ta	-20	85	°C

Table 3. Recommended Operating Conditions

Electrical Characteristics (Ta=25°C, V_{CC}=12V, unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Supply voltage	V_{CC}	-	3.5	-	24	V
Output zener breakdown	V_Z	-	-	46	-	V
Output saturation voltage	V_{SAT}	I_O=300mA	-	0.3	0.6	V
Output leakage current	I_{CEX}	V_{CC} =V_{CE}	-	0.1	10	uA
Supply current	I_{CC}	V_{CC} =20V, output open	-	12	16	mA
Output rise time	t_r	R_L=820Ω, C_L=20pF	-	3.0	10	us
Output falling time	t_f	R_L=820Ω, C_L=20pF	-	0.3	1.5	us
Switch time differential	Δt	R_L=820Ω, C_L=20pF	-	3.0	10	us

Table 4. Electrical Characteristics

Magnetic Characteristics (Ta=25°C, V_{CC}=24V, unless otherwise specified)

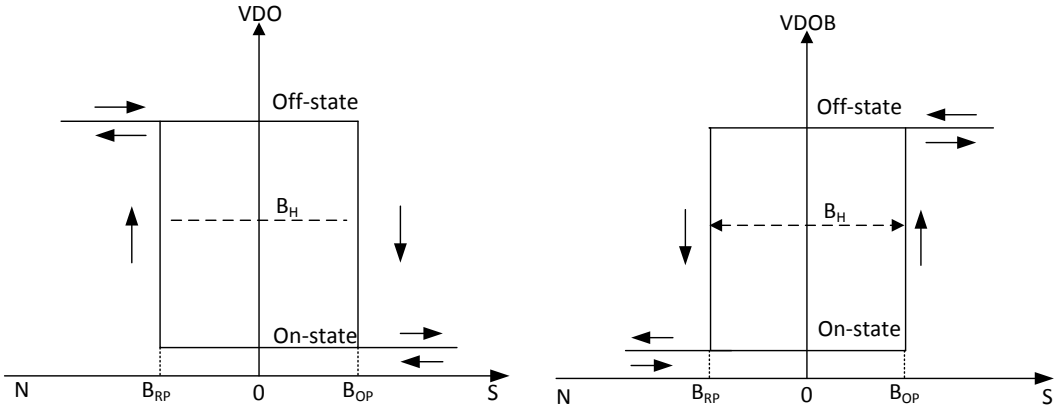


Figure 4. Magnetic Characteristics

Grade A

Parameter	Symbol	Min	Max	Unit
Operate point	B_{OP}	10	50	GS
Release point	B_{RP}	-50	-10	GS

Grade B

Parameter	Symbol	Min	Max	Unit
Operate point	B_{OP}	5	70	GS
Release point	B_{RP}	-70	-5	GS

Grade C

Parameter	Symbol	Min	Max	Unit
Operate point	B_{OP}	-	90	GS
Release point	B_{RP}	-90	-	GS

Grade D

Parameter	Symbol	Min	Max	Unit
Operate point	B_{OP}	-	125	GS
Release point	B_{RP}	-125	-	GS

Typical Performance Characteristics

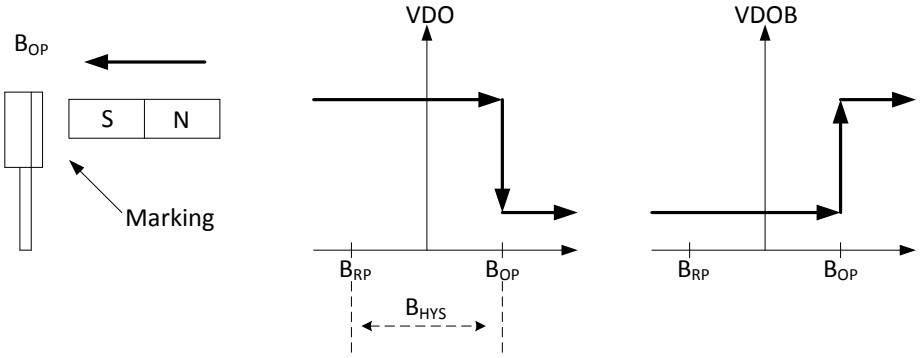


Figure 5. Magnetic Characteristics

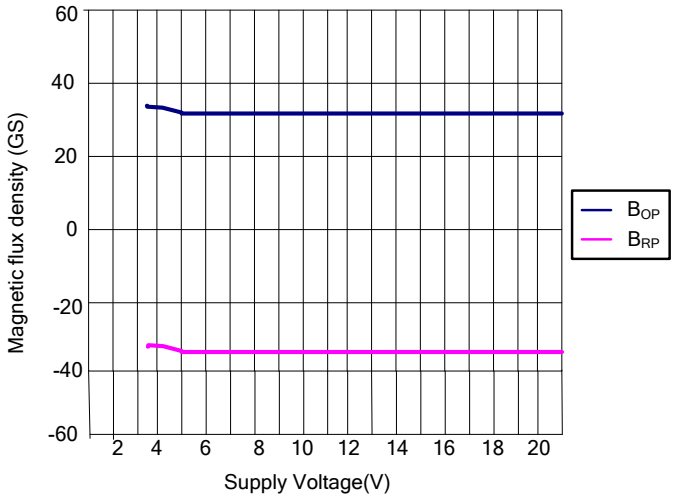


Figure 5. Typical Magnetic Switch Point vs. Supply Voltage

Typical Application

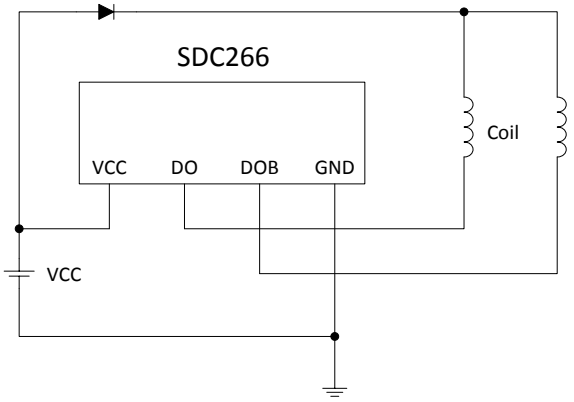
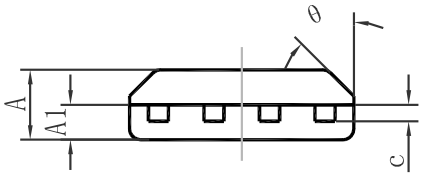
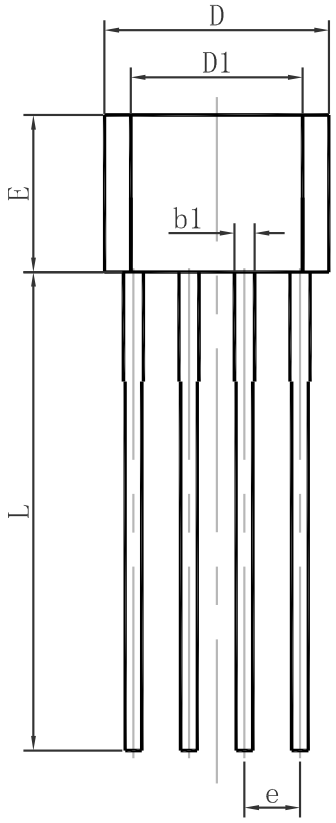


Figure 6. Typical Application

Package Dimension

TO-94





Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.400	1.800	0.055	0.071
A1	0.700	0.900	0.028	0.035
b1	0.380	0.550	0.015	0.022
C	0.360	0.510	0.014	0.020
D	5.050	5.350	0.202	0.214
D1	4.550	4.850	0.128	0.194
E	3.450	3.750	0.136	0.148
e	1.270 TYP.		0.050 TYP.	
L	14.300	14.700	0.572	0.588
θ	10°TYP.		10°TYP.	

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